



March 1993
Revised September 2000

74ACTQ32 Quiet Series Quad 2-Input OR Gate

General Description

The ACTQ320 contains four, 2-input OR gates and utilizes Fairchild Quiet Series technology to guarantee quiet output switching and improved dynamic threshold performance. FACT Quiet Series™ features GTO™ output control and undershoot corrector in addition to a split ground bus for superior AC/DC performance.

Features

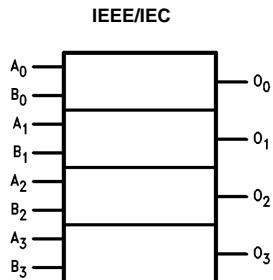
- I_{CC} reduced by 50%
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Improved latch-up immunity
- Minimum 4 kV ESD protection
- TTL-compatible inputs
- Outputs source/sink 24 mA

Ordering Code:

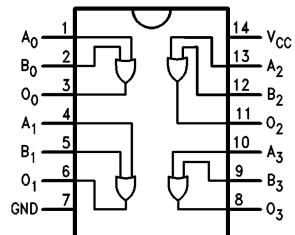
Order Number	Package Number	Package Description
74ACT32SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
74ACT32SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74ACT32PC	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Descriptions
A_n, B_n	Inputs
\bar{O}_n	Outputs

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Absolute Maximum Ratings ^(Note 1)							Recommended Operating Conditions	
Supply Voltage (V_{CC})			-0.5V to +7.0V		Supply Voltage (V_{CC})	4.5V to 5.5V		
DC Input Diode Current (I_{IK})			$V_I = -0.5V$	-20 mA	Input Voltage (V_I)	0V to V_{CC}		
			$V_I = V_{CC} + 0.5V$	+20 mA	Output Voltage (V_O)	0V to V_{CC}		
DC Input Voltage (V_I)			-0.5V to $V_{CC} + 0.5V$		Operating Temperature (T_A)	-40°C to +85°C		
DC Output Diode Current (I_{OK})			$V_O = -0.5V$	-20 mA	Minimum Input Edge Rate ($\Delta V/\Delta t$)			
			$V_O = V_{CC} + 0.5V$	+20 mA	V_{IN} from 0.8V to 2.0V			
DC Output Voltage (V_O)			-0.5V to $V_{CC} + 0.5V$		V_{CC} @ 4.5V, 5.5V	125 mV/ns		
DC Output Source or Sink Current (I_O)			± 50 mA					
DC V_{CC} or Ground Current per Output Pin (I_{CC} or I_{GND})			± 50 mA					
Storage Temperature (T_{STG})			-65°C to +150°C					
DC Latch-Up Source or Sink Current			± 300 mA					
Junction Temperature (T_J) PDIP			140°C					
DC Electrical Characteristics								
Symbol	Parameter	V_{CC} (V)	$T_A = +25^\circ C$		$T_A = -55^\circ C$ to $+125^\circ C$	$T_A = -40^\circ C$ to $+85^\circ C$	Units	Conditions
			Typ		Guaranteed Limits			
V_{IH}	Minimum HIGH Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
V_{IL}	Maximum LOW Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
V_{OH}	Minimum HIGH Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	4.4 5.4	V	$I_{OUT} = -50$ μA
		4.5 5.5		3.86 4.66	3.70 4.70	3.76 4.76	V	$V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -24$ mA $I_{OH} = -24$ mA (Note 2)
V_{OL}	Maximum LOW Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	0.1 0.1	V	$I_{OUT} = 50$ μA
		4.5 5.5		0.36 0.36	0.50 0.50	0.44 0.44	V	$V_{IN} = V_{IL}$ or V_{IH} $I_{OL} = 24$ mA $I_{OL} = 24$ mA (Note 2)
I_{IN}	Maximum Input Leakage Current	5.5		± 0.1	± 1.0	± 1.0	μA	$V_I = V_{CC}$, GND
I_{CCT}	Maximum I_{CO} /Input	5.5	0.6		1.6	1.5	mA	$V_I = V_{CC} - 2.1V$
I_{OLD}	Minimum Dynamic Output Current (Note 3)	5.5			50	75	mA	$V_{OLD} = 1.65V$ Max
I_{OHD}		5.5			-50	-75	mA	$V_{OHD} = 3.85V$ Min
I_{CC}	Maximum Quiescent Supply Current	5.5		2.0	40.0	20.0	μA	$V_{IN} = V_{CC}$ or GND
V_{OLP}	Quiet Output Maximum Dynamic V_{OL}	5.0	1.1	1.5			V	Figures 1, 2 (Note 4)(Note 5)
V_{OLV}	Quiet Output Minimum Dynamic V_{OL}	5.0	-0.6	-1.2			V	Figures 1, 2 (Note 4)(Note 5)
V_{IHD}	Minimum HIGH Level Dynamic Input Voltage	5.0	1.9	2.2			V	(Note 4)(Note 6)
V_{ILD}	Maximum LOW Level Dynamic Input Voltage	5.0	1.2	0.8			V	(Note 4)(Note 6)
<small>Note 2: All outputs loaded; thresholds on input associated with output under test.</small>								
<small>Note 3: Maximum test duration 2.0 ms, one output loaded at a time.</small>								
<small>Note 4: DIP Package.</small>								
<small>Note 5: Max number of outputs defined as (n). Data inputs are 0V to 3V. One output @ GND.</small>								
<small>Note 6: Max number of data inputs (n) switching. (n-1) inputs switching 0V to 3V (ACTQ). Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{IHD}), f = 1 MHZ.</small>								

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V) (Note 7)	T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF		Units
			Min	Typ	Max	Min	Max	
t _{PLH}	Propagation Delay Data to Output	5.0	2.5	6.0	6.5	2.5	7.0	ns
t _{PHL}	Propagation Delay Data to Output	5.0	2.0	6.0	6.5	2.5	7.0	ns
t _{O_{SHL}} t _{O_{SLH}}	Output to Output Skew (Note 8)	5.0		0.5	1.0		1.0	ns

Note 7: Voltage Range 5.0 is 5.0V \pm 0.5V.

Note 8: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{O_{SHL}}) or LOW-to-HIGH (t_{O_{SLH}}). Parameter guaranteed by design.

Capacitance

Symbol	Parameter	Typ	Units	Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = OPEN
C _{PD}	Power Dissipation Capacitance	68	pF	V _{CC} = 5.0V

FACT Noise Characteristics

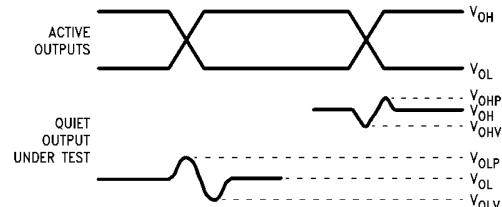
The setup of a noise characteristics measurement is critical to the accuracy and repeatability of the tests. The following is a brief description of the setup used to measure the noise characteristics of FACT.

Equipment

Hewlett Packard Model 8180A Word Generator
PC-163A Test Fixture
Tektronics Model 7854 Oscilloscope

Procedure:

1. Verify Test Fixture Loading: Standard Load 50 pF, 500Ω.
2. Deskew the HFS generator so that no two channels have greater than 150 ps skew between them. This requires that the oscilloscope be deskewed first. It is important to deskew the HFS generator channels before testing. This will ensure that the outputs switch simultaneously.
3. Terminate all inputs and outputs to ensure proper loading of the outputs and that the input levels are at the correct voltage.
4. Set the HFS generator to toggle all but one output at a frequency of 1 MHz. Greater frequencies will increase DUT heating and effect the results of the measurement.



V_{OHV} and V_{OLP} are measured with respect to ground reference.

Input pulses have the following characteristics: $f = 1$ MHz, $t_r = 3$ ns, $t_f = 3$ ns, skew < 150 ps.

FIGURE 1. Quiet Output Noise Voltage Waveforms

5. Set the HFS generator input levels at 0V LOW and 3V HIGH for ACTQ devices and 0V LOW and 5V HIGH for AC devices. Verify levels with an oscilloscope.

V_{OLP}/V_{OLV} and V_{OHP}/V_{OHV} :

- Determine the quiet output pin that demonstrates the greatest noise levels. The worst case pin will usually be the furthest from the ground pin. Monitor the output voltages using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- Measure V_{OLP} and V_{OLV} on the quiet output during the worst case transition for active and enable. Measure V_{OHP} and V_{OHV} on the quiet output during the worst case transition.
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

V_{ILD} and V_{IHD} :

- Monitor one of the switching outputs using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- First increase the input LOW voltage level, V_{IL} , until the output begins to oscillate or steps out a min of 2 ns. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input LOW voltage level at which oscillation occurs is defined as V_{ILD} .
- Next decrease the input HIGH voltage level, V_{IH} , until the output begins to oscillate or steps out a min of 2 ns. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input HIGH voltage level at which oscillation occurs is defined as V_{IHD} .
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

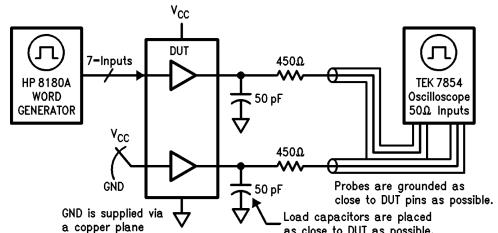
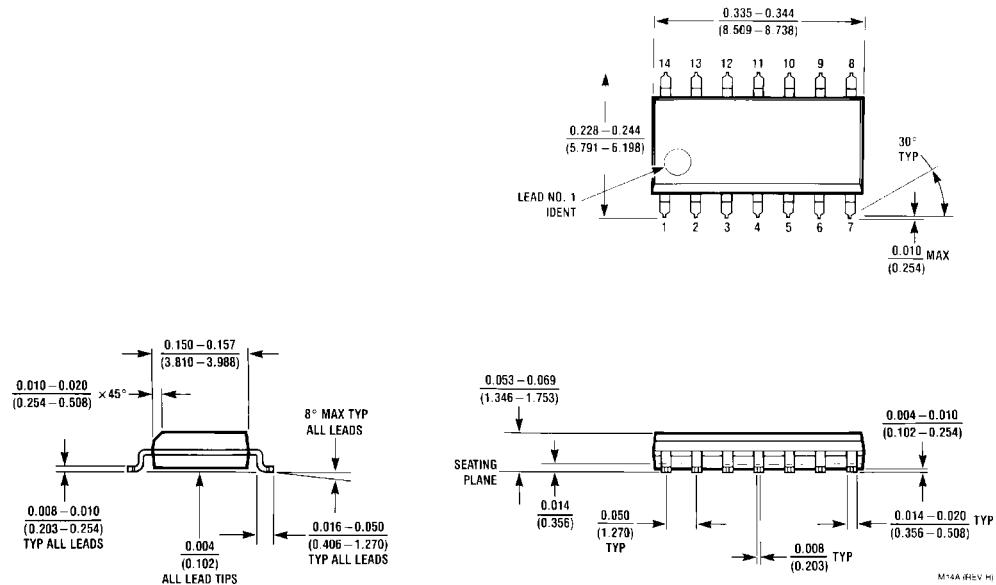


FIGURE 2. Simultaneous Switching Test Circuit

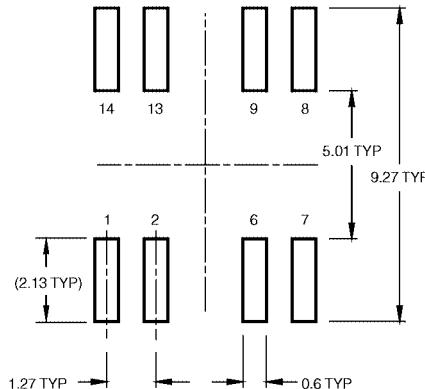
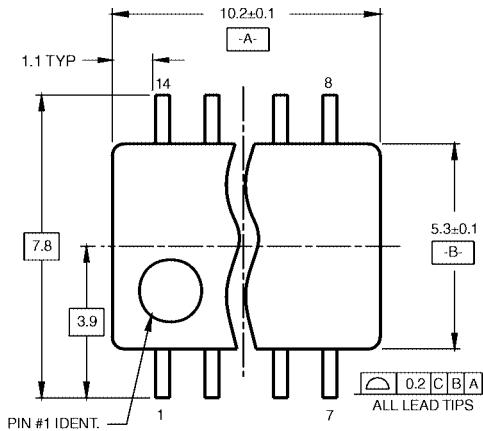
Physical Dimensions inches (millimeters) unless otherwise noted



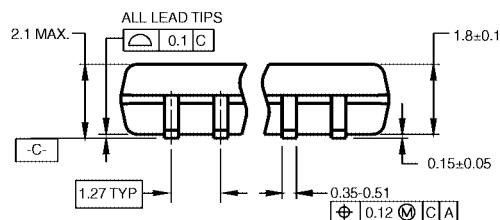
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
Package Number M14A

74ACTQ32

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



LAND PATTERN RECOMMENDATION

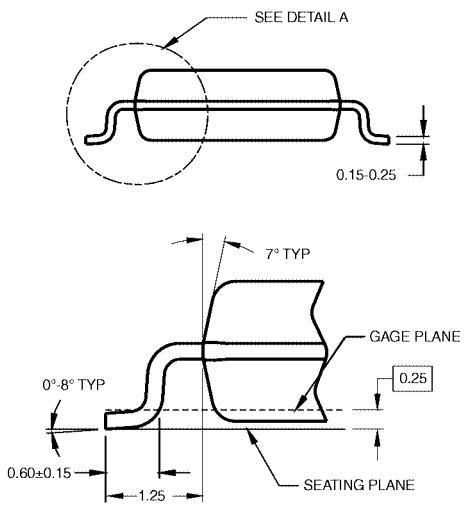


DIMENSIONS ARE IN MILLIMETERS

NOTES:

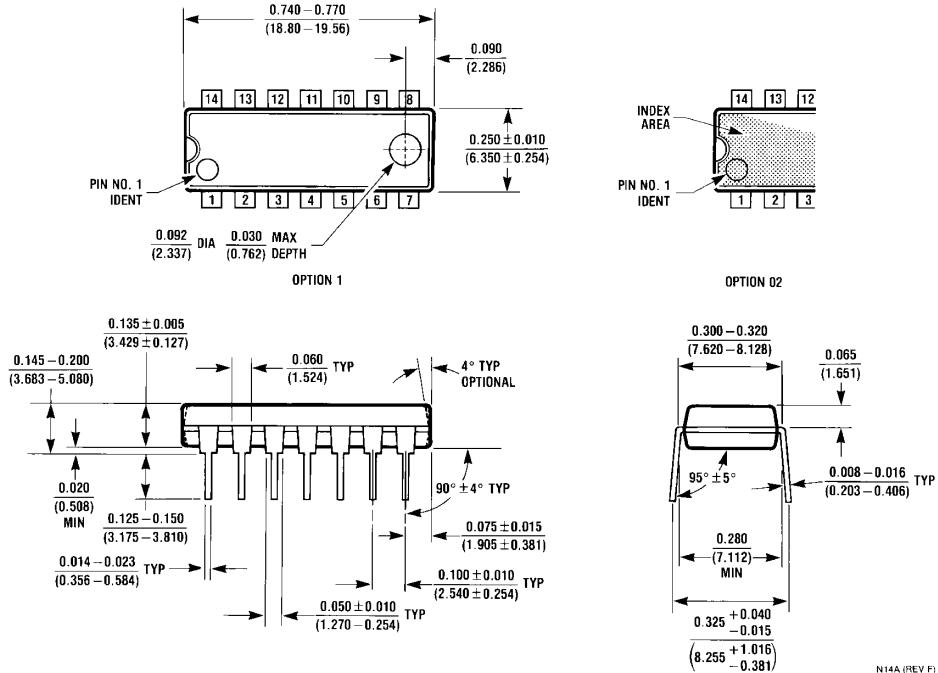
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M14DRevB1



**14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

N14A (REV F)

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